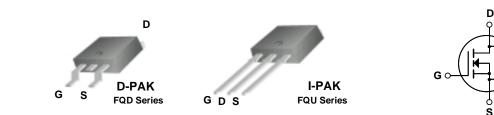
## FAIRCHILD January 2009 SEMICONDUCTOR TM OFE FQD13N10 / FQU13N10 **100V N-Channel MOSFET General Description** Features • 10A, 100V, $R_{DS(on)} = 0.18\Omega @V_{GS} = 10 V$ • Low gate charge ( typical 12 nC) These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. Low Crss (typical 20 pF) • This advanced technology has been especially tailored to Fast switching minimize on-state resistance, provide superior switching • 100% avalanche tested performance, and withstand high energy pulse in the Improved dv/dt capability

minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as audio amplifier, high efficiency switching DC/DC converters, and DC motor control.

- RoHS Compliant
- Stoll Stoll

FQD13N10 / FQU13N10



# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQD13N10 / FQU13N10	Units
V <sub>DSS</sub>	Drain-Source Voltage		100	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°	°C)	10	А
	- Continuous (T <sub>C</sub> = 100	)°C)	6.3	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	40	Α
V <sub>GSS</sub>	Gate-Source Voltage		± 25	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	95	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	10	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	4.0	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
P <sub>D</sub>	Power Dissipation ( $T_A = 25^{\circ}C$ ) *		2.5	W
	Power Dissipation ( $T_C = 25^{\circ}C$ )		40	W
	- Derate above 25°C		0.32	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
Τ <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

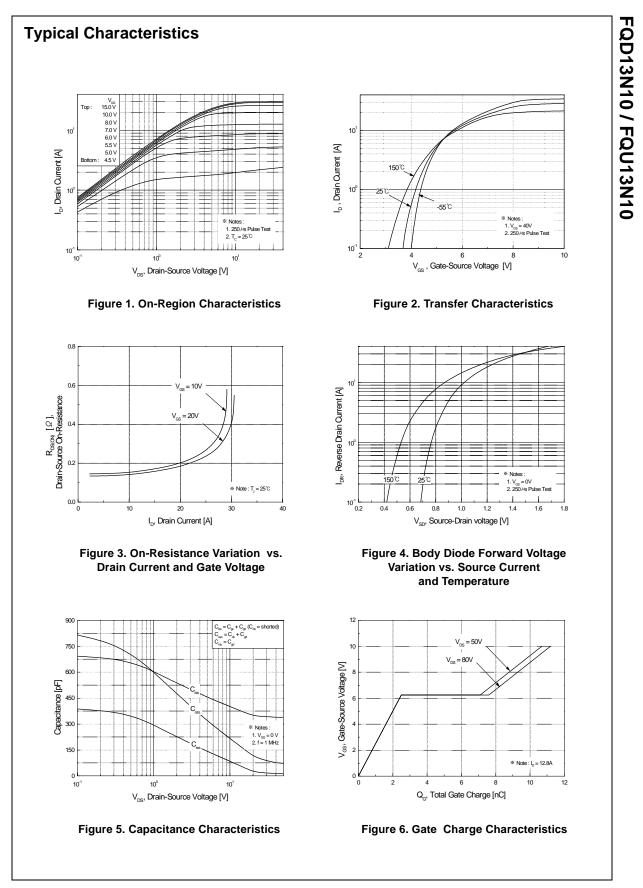
# **Thermal Characteristics**

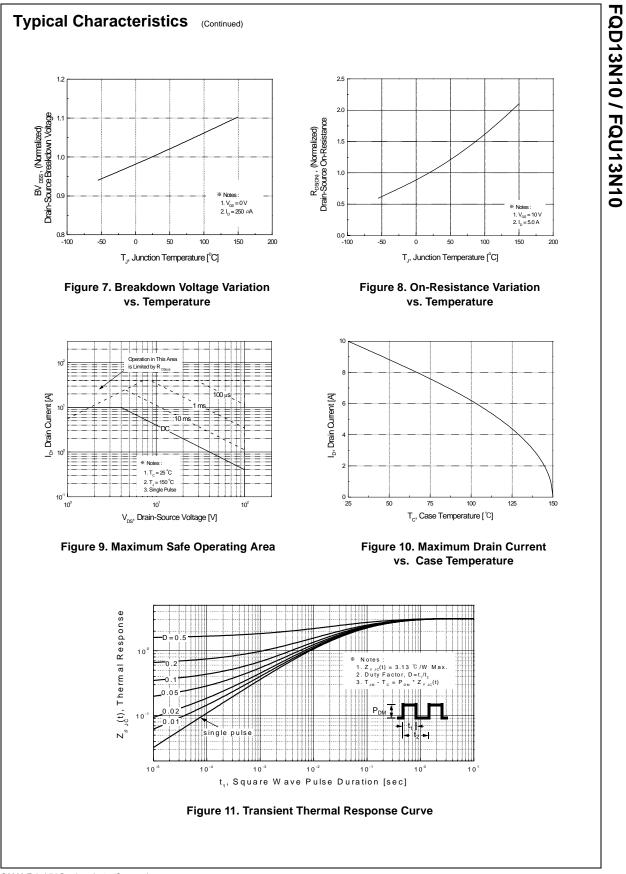
Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		3.13	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W

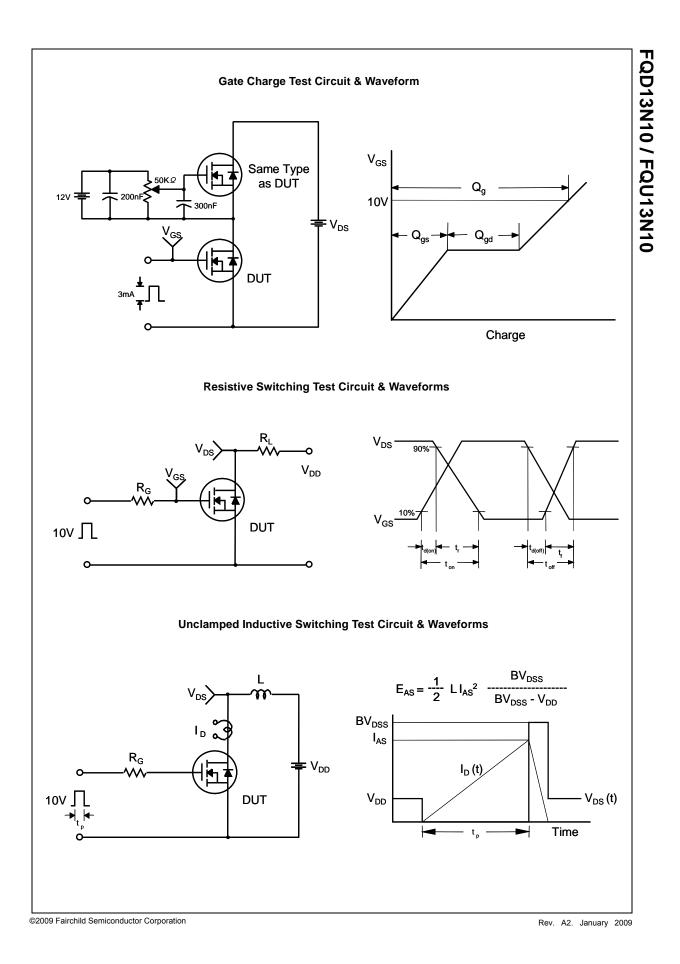
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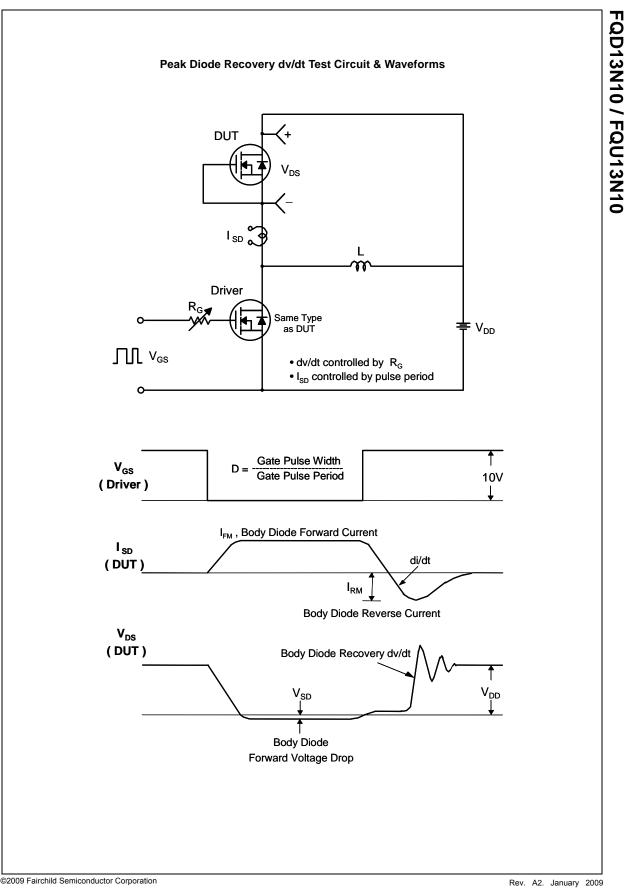
Symbol	Parameter	Test Conditions	;	Min	Тур	Max	Units
Off Cha	racteristics						
BV <sub>DSS</sub> Drain-Source Breakdown Voltage		V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		100			V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced	to 25°C		0.09		V/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
		$V_{DS} = 80 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$				10	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 25 V, V_{DS} = 0 V$				100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS}$ = -25 V, $V_{DS}$ = 0 V				-100	nA
On Cha	racteristics						
GS(th)	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.0 A			0.142	0.18	Ω
Ĵfs	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 5.0 A	(Note 4)		6.3		S
		1			1	1	
	ic Characteristics	1			- 1 <b>-</b>		_
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			345	450	pF
Coss	Output Capacitance				100	130	pF
Srss	Reverse Transfer Capacitance				20	25	pF
Switchi	ng Characteristics						
d(on)	Turn-On Delay Time	$V_{DD} = 50 \text{ V}, I_{D} = 12.8 \text{ A},$			5	20	ns
r	Turn-On Rise Time	$R_{G} = 25 \Omega$			55	120	ns
d(off)	Turn-Off Delay Time	0			20	50	ns
f	Turn-Off Fall Time		(Note 4, 5)		25	60	ns
ל <sup>g</sup>	Total Gate Charge	$V_{DS} = 80 \text{ V}, I_{D} = 12.8 \text{ A},$			12	16	nC
ຊ <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V			2.5		nC
ጋ <sub>gd</sub>	Gate-Drain Charge		(Note 4, 5)		5.1		nC
Drain-S	ource Diode Characteristics a	nd Maximum Rating	e				
s	Maximum Continuous Drain-Source Dic		0			10	А
SM	Maximum Pulsed Drain-Source Diode F	Forward Current				40	А
/ <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 10 A				1.5	V
rr	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 12.8 A,$			72		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> / dt = 100 A/μs	(Note 4)		0.17		μC
L = 1.43mH, I <sub>SD</sub> ≤ 12.8A Pulse Test :	ating : Pulse width limited by maximum junction temper $I_{AS} = 10A$ , $V_{DD} = 25V$ , $R_G = 25 \Omega$ , Starting $T_J = 25^{\circ}C$ , di/dt $\leq 300A/\mus$ , $V_{DD} \leq BV_{DSS}$ , Starting $T_J = 25^{\circ}C$ Pulse width $\leq 300\mu$ s, Duty cycle $\leq 2\%$ adependent of operating temperature						

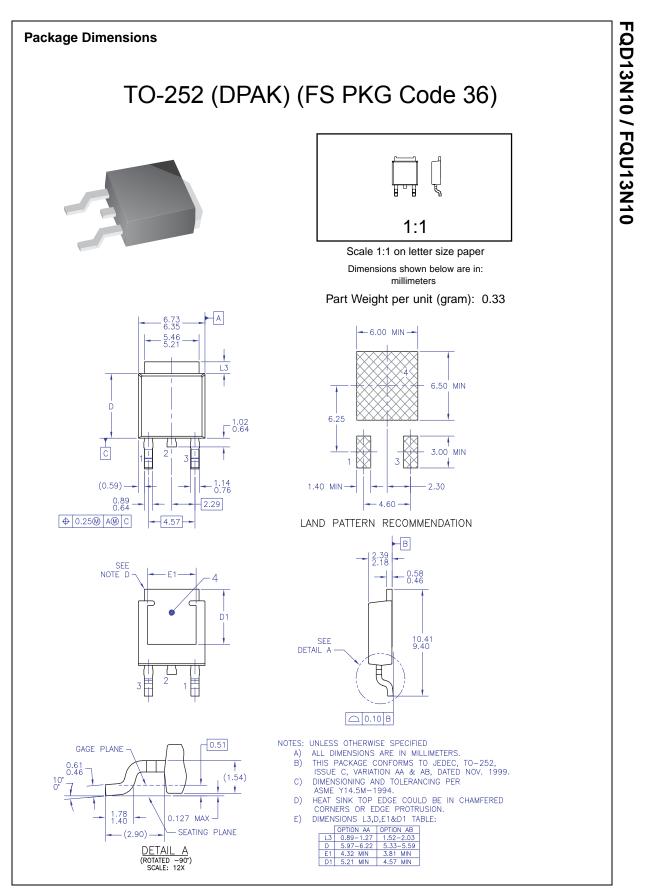
FQD13N10 / FQU13N10

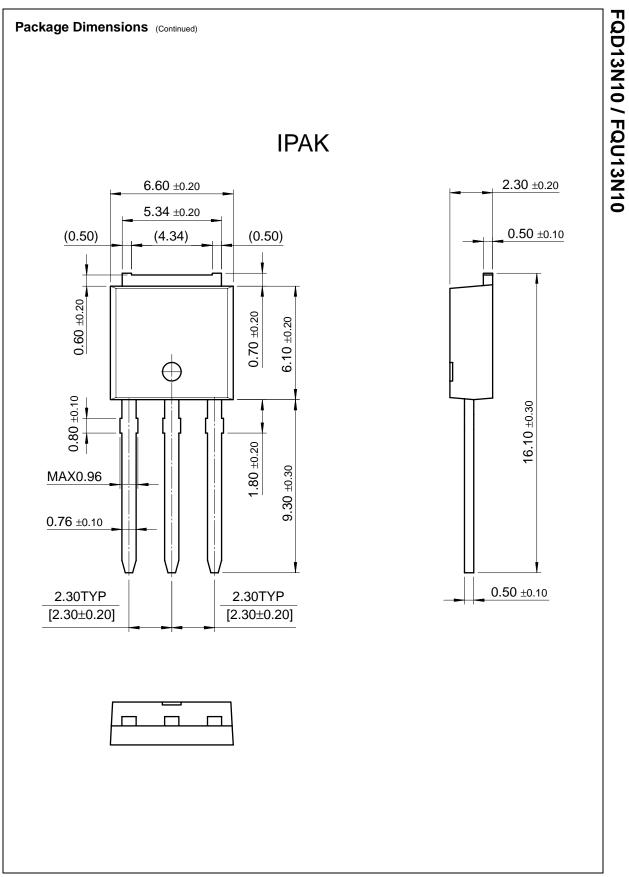














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